

# Product Specification

## XBLW SN75176B/SN65176B

Multipoint RS-485/RS-422





#### Description

The SN75176B / SN65176B is a high speed differential TRI-STATE® bus/line transceiver designed to meet the requirements of EIA standard RS485 with extended common mode range (+12V to -7V), for multipoint data transmission. In addition, it is compatible with RS-422.

The driver and receiver outputs feature TRI-STATE capability, for the driver outputs over the entire common mode range of +12V to -7V. Bus contention or fault situations that cause excessive power dissipation within the device are handled by a thermal shutdown circuit, which forces the driver outputs into the high impedance state. DC specifications are guaranteed over the 0 to 70°C temperature and 4.75V to 5.25V supply voltage range.

#### Features

- > Meets EIA Standard RS485 for Multipoint Bus Transmission and is Compatible with RS-422.
- > Small Outline (SOIC) Package Option Available for Minimum Board Space.
- > 22 ns Driver Propagation Delays.
- ➢ Single +5V Supply.
- > -7V to +12V Bus Common Mode Range Permits  $\pm 7V$  Ground Difference Between Devices on the Bus.
- > Thermal Shutdown Protection.
- ➢ High Impedance to Bus with Driver in TRISTATE or with Power Off, Over the Entire Common Mode Range Allows the Unused Devices on the Bus to be Powered Down.
- > Combined Impedance of a Driver Output and Receiver Input is Less Than One RS485 Unit Load,
- Allowing up to 32 Transceivers on the Bus.

> 70 mV Typical Receiver Hysteresis.

#### **Connection and Logic Diagram**



Figure 1. Top View

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam

during storage or handling to prevent electrostatic damage to the MOS gates.

#### **Order Information**

Product Model	Package Type	Marking	Packing	Packing Qty
SN65176BN	DIP-8	65176BN	Tube	2000/Box
SN65176BDR	SOP-8	65176B	Таре	2500/Reel
SN75176BN	DIP-8	75176BN	Tube	2000/Box
SN75176BDR	SOP-8	75176B	Таре	2500/Reel



#### Absolute Maximum Ratings (1)(2)

Supply Volta	age, VCC	7 V
Control Inpu	ut Voltages	7 V
Driver Inpu	ut Voltage	7 V
Driver Outp	ut Voltages	+15V/ - 10V
Receiver Inp	out Voltages	+15V/ - 10V
Receiver Out	tput Voltage	5 .5V
Continuous Power Dissination @25°C	for SOIC Package	675 mW(3)
Continuous Fower Dissipation @25 C	for PDIP Package	900 mW(4)
Storage Tempe	-65 ° C to +15 0 ° C	
Lead Temperature ( S	2 60 ° C	
ESD Ratir	ng (HBM)	500V

(1)"Absolute Maximum Ratings" are those beyond which the safety of the device cannot be verified. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" provide conditions for actual device operation.

(2) If Military/Aerospace specified devices are required, please contact the HG Sales Office/Distributors for availability and specifications.

(3) Derate linearly @ 6.11 mW/°C to 400 mW at 70°C.

(4) Derate linearly at 5.56 mW/°C to 650 mW at 70°C.

#### **Recommended Operating Conditions**

	Min	Max	Units
Suppl yVol tage, VCC	4 .75	5 .25	V
Units Voltageat AnyBusTerminal (SeparateorCommonMode)	-7	+ 12	V
OperatingFreeAirTemperatureTA			-
SN75176B	0	+70	°C
SN65176B	-40	+ 105	°C
Differential InputVol tage, VID(1)	- 12	+12	V

(1) Differential - Input/Output bus voltage is measured at the noninverting terminal A with respect to the inverting terminalB.

### Electrical Characteristics(1) (2)

 $0^{\circ}C \le TA \le 70^{\circ}C$ , 4.75V < VCC < 5.25V unless otherwise specified

Symbol	Parameter		Conditions		Тур	Max	Units
V <sub>OD1</sub>	Differential Driver Output Voltage (Unloaded)	I <sub>O</sub> = 0				5	V
V <sub>OD2</sub>	Differential Driver Output	See (Figure 2)	R = 50Ω; (RS-422) <sup>(3)</sup>	2			V
	Voltage (with Load)		R = 27Ω; (RS-485)	1.5			V
ΔV <sub>OD</sub>	Change in Magnitude of Driver						
	Differential Output Voltage For					0.2	V
	Complementary Output States						
Voc	Driver Common Mode Output Voltage	See (Figure 2)	R = 27Ω			2.0	V
Δ V <sub>OC</sub>	Change in Magnitude of Driver					3.0	V
	Common Mode Output Voltage					0.0	
	For Complementary Output States					0.2	V

(1) All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.

(2) All typicals are given for VCC = 5V and TA =  $25^{\circ}$ C.

(3) All worst case parameters for which this note is applied, must be increased by 10% for SN75176BT. The other parameters remain valid for  $-40^{\circ}$ C < TA <  $+85^{\circ}$ C.





#### **Electrical Characteristics** <sup>(1) (2)</sup> (continued)

0 °C  $\leq$  TA $\leq$  70 °C, 4.75V < VCC< 5.25V unless otherwise specified

Symb o I	P aram et er		C	on dition s		Min	Ту р	Max	Units
VIH	Input High Voltage		1			2			V
VIL	Input Low Voltage							0.8	
VCL	Input Clamp Voltage	DI, DE,	,RE, E	IIN = -18	s mA			- 1.5	
IIL	Input Low Current			VIL = 0.	4V			-200	pА
Іін	Input High Current			VIH = 2 .	4 V			20	pА
IIN	Input Current DO / R	I, DO /	$V_{CC} = 0 V \text{ or}$	VIN = 1	2 V			+1.0	mA
		RI	5.25V	VIN = -	7 V			-0.8	mA
			D E = 0 V						
V TH	Differential Input Threshold	Voltage	– 7V ≤	VCM $\leq$ + 12 V		-0.2		+0.2	V
	for Receiver								
Δ Vth	Receiver Input Hys	teresis	V	CM = 0 V			70		mV
V он	Receiver Output High Vo	ltage	IOH	= -40 0 pA		2.7			V
Vol	Output Low Voltage F	20	IOL =	16 (3) mA				0.5	V
Ioz r	OFF- State ( High Imp	edance)	VC	C = Max				±20	pА
	Output Current at R	eceiver	0 .4V	$\leq$ VO $\leq$ 2 .4V					
Rin	Receiver Input Res	istance	–7V ≤	VCM $\leq$ +12 V		12			kQ
Icc	Supply Current		No Load(3)	Driver Outputs	Enabled			55	mA
				Driver Outputs	Disabled			35	mA
Iosd	Driver Short- Circuit C	Dutput	Vo	∋= −7 V ( 3 )				-250	mA
	Current		V	o=+12V (3)				+250	mA
I OSR	Receiver Short-Circuit Outpu	t Current	V	o = 0 V		- 15		-85	mA

#### **Switching Characteristics**

#### VCC = 5.0V, TA = 25 °C

Symb o I	Parameter	Conditions	Min	Тур	Max	Unit s
<b>t</b> PLH	Driver Input to Output	RLDIFF=60Q		12	22	ns
<b>t</b> PHL	Driver Input to Output	CL1=CL2=100pF		17	22	ns
tr	Driver Rise Time	RI DIFE=600			18	ns
tr	Driver Fall Time	CL1=CL2=100pF (Figure 4 and Figure 6)			18	ns
tzн	Driver Enable to Output High	C∟=100pF(Figure5andFigure7)S1 Open		29	100	ns
tzı	Driver Enable to Output Low	C∟=100pF(Figure5andFigure7)S2 Open		31	60	ns
tız	Driver Disable Time from Low	CL=15pF(Figure5andFigure7)S2 Open		13	30	ns
tнz	Driver Disable Time from High	CL=15pF(Figure5andFigure7)S1 Open		19	2 00	ns
<b>t</b> plh	Receiver Input to Output	CL=15pF(Figure3andFigure8)		30	37	ns
<b>t</b> PHL	Receiver Input to Output	S1 and S2 Closed		32	37	ns
tzl	Receiver Enable to Output Low	CL=15pF(Figure3andFigure9)S2 Open		15	20	ns
tzн	Receiver Enable to Output High	C∟=15pF(Figure3andFigure9)S1 Open		11	20	ns
t LZ	Receiver Disable from Low	C∟=15pF(Figure3andFigure9)S2 Open		28	32	ns
tнz	Receiver Disable from High	CL=15pF(Figure3andFigure9)S1 Open		13	35	ns



## XBLW SN75176B/SN65176B

#### Multipoint RS-485/RS-422

#### AC TEST CIRCUITS



#### **Switching Time Waveforms**



Figure 6. Driver Propagation Delays and Transition Times



![](_page_4_Figure_9.jpeg)

![](_page_5_Picture_0.jpeg)

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![](_page_5_Figure_3.jpeg)

Note: Differential input voltage may may be realized by grounding RI and pulsing RI between +2.5V and -2.5V Figure 8. Receiver Propagation Delays

![](_page_5_Figure_5.jpeg)

Figure 9. Receiver Enable and Disable Times

#### **Function Tables**

Table 1. SN75176B Transmitting(1)

Inputs		Line Condition	Outputs		
RE	DE	DI		DO	DO
Х	1	1	No Fault	0	1
X	1	0	No Fault	1	0
X	0	Х	х	Z	Z
X	1	X	Fault	Z	Z

X — Don't care condition Z — High impedance state Fault — Improper line conditons causing excessive power dissipation in the driver, such as shorts or bus contention situations \*\*This is a fail safe condition

Inputs			Outputs
RE	DE	RI-RI	RO
0	0	≥ +0.2V	1
0	0	≤ -0.2V	0
0	0	Inputs Open**	1
1	0	Х	Z

Table 2. SN75176B Receiving(1)

(1) X — Don't care condition Z — High impedance state Fault — Improper line conditons causing excessive power dissipation in the driver, such as shorts or bus contention situations \*\*This is a fail safe condition

![](_page_6_Picture_0.jpeg)

## Package Outline Dimensions

SOP-8

![](_page_6_Figure_5.jpeg)

![](_page_6_Figure_6.jpeg)

SYMPOL	MILLIMETER					
STMBOL	MIN	NOM	МАХ			
A	1.55	1.65	1.75			
A1	0.10	0.15	0.20			
A2	1.35	1.45	1.55			
A3	0.60	0.70	0.80			
b	0.30	0.40	0.50			
с	0.17	0.20	0.25			
D	4.80	4.90	5.00			
E	5.80	6.00	6.20			
E1	3.80	3.90	4.00			
e		1.27BSC				
L	0.50	0 0.60 0.7				
L1		1.05REF				
θ	0°	4°	8°			

![](_page_7_Picture_0.jpeg)

DIP-8

![](_page_7_Figure_4.jpeg)

	Dimensions in Millimeters					
Symbol	Min	Nom	Max			
А			4.31			
A1	3.15	3.30	3.65			
В	0.38	0.46	0.51			
B1	1.27	1.55	1.77			
С	0.20	0.25	0.30			
D	8.95	9.40	9.45			
Е	6.15	6.20	6.65			
E1		7.60				
e		2.54				
L	3.00	3.30	3.60			

![](_page_8_Picture_0.jpeg)

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